

DECLARATION FOR PATENT APPLICATION

As a Delow named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name; I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

MANUFACTURING METHOD FOR A SEMICONDUCTOR DEVICE,

the specificat	tion of which (ch	eck one); 🛘 is attached as Application Serial A	hereto: X	was filed on JUL	Y 10, 2003	
referred to at accordance wit under Title 35	ne above-identific bove. I acknowled th Title 37, Code 5, United States (	(if applicable). If applicable (if applicable). If applicable (if application, including the duty to disclose of Federal Regulations, code, §119 of any foreight of the application or	I hereby sta ding the cla e information , §1.56(a). gn application	te that I have re ims, as amended by n which is materia I hereby claim fo on(s) for patent (	viewed and understa y any amendment(s) al to patentability preign priority ber	and the y in nefits
Prior	Foreign Applicati	ion(s)			Priority C	laimed
2002-202508				X		
(Number)	(Country)	(Day/Month/Year f	iled)		Yes	No
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(Number)	(Country)	(Day/Month/Year Filed)		Yes	No	
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(Number)	(Country)	(Day/Month/Year F	rited)		Yes _	No
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application(s) not disclosed 35, United Sta patentability	listed below and in the prior Unit ites Code, §112, I as defined in Tit	efit under Title 35, Uni I, insofar as the subjec Led States application i acknowledge the duty t le 37, Code of Federal Lation and the national	t matter of n the manner o disclose i Regulations,	each of the claim r provided by the information which , §1.56(a) which o	ns of this applicat first paragraph of is material to occurred between th	Title ie
(Application Serial No.) (Filing Date)				(Status - Patent	ed, Pending or Aba	andoned)
(Application S	erial No.)	(Filing Date)		(Status - Patent	ed, Pending or Aba	indoned)
statements mad made with the imprisonment,	le on information knowledge that wi or both, under Se	all statements made here and belief are believed llful false statements ction 1001 of Title 18 alidity of the applicat	to be true; and the like of the Unite	and further that so made are puni d States Code and	these statements shable by fine or Ithat such willful	
		POWER OF	ATTORNEY			
and Franco S. 1 31st Floor, Ne	De Liguori, Regis w York, New York his application,	Bruce L. Adams, Registra tration No. 36,497 whos 10004, as my (our) atto and to transact all bus	e post offic rneys with f	e address is: Ada full power of subs	ms & Wilks, 50 Bro titution and revoc	adway, ation,
Full Name of F	irst or Sole Inve	ntor	Citizenshi	Р	-	
Hitomi WATANAB SAKUR			JAPAN			
RESIDENCE Addr			POST OFFIC	E Address - Stree	t	
c/o Seiko Insti 8, Nakase 1-ch			same as re	sidence address		
City (Zip)			City (Zip)			
Chiba-shi, Chil	ba 261-8507		,,.			
State or Count	гу	<del></del>	State or C	ouncry	<u> </u>	
JAPAN	•					
Date /			Signature /			
	tember 18,		Sku	tomes 8		<del></del>
☐ See second	page for addition	nal joint inventors.				